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Road for macroporous silicon stabilization by ultrathin ALD TiO₂ coating

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Macroporous silicon films have a great potential for plethora of applications in optoelectronics and microelectronics. However, one has to admit that such layers are too electrically and chemically unstable to be used in fuel cells, supercapacitors or any devices requiring the use of an electrolyte. This is due to their high surface-to-volume ratio, which makes them prone to chemical reactions, such as photo-oxidation, especially in aqueous media. In this work, we investigated how to benefit from the capabilities of macroporous silicon while avoiding its oxidation. To do so, we explored the influence of ultrathin TiO_2 films by Atomic Layer Deposition (ALD) onto the walls of silicon macropores, created by electrochemical etching from n-type wafers. Using microscopy and optical analysis we demonstrate the achievability of ALD coating of macroporous silicon, as well as the stability of these films against oxidation. In particular, we show that 5 ALD cycles, that correspond to less than 1 nm thin coating, are sufficient to passivate the silicon surface. The coated and uncoated layers were analyzed and compared before and after exposure to water and sunlight. The monitoring of the Si-O-Si band area evolution over 29 days gave no evidence of the photo-corrosion. In addition, the wettability of the samples did not change after functionalization. Finally, to investigate oxidation prevention for photocatalytic applications, we show that methylene blue degradation rates were significantly increased (by 50% on average) for 10 nm TiO₂ ALD-coated porous silicon samples compared to natural degradation. Interestingly, layers thinner than 1nm also showed enhanced catalytic kinetics at short times (t < 40 min).

Introduction

As stated a few years ago by Rasson and Francis,¹ porous silicon's (PSi) semi-conducting and optical properties, as well as its large specific surface area, make it interesting for numerous applications. Among them, we can point out electronic components, which mainly benefit from its dielectric properties. The obtainable relative dielectric constant varying from 2 to 6 depending on PSi's porosity.² Moreover, PSi's use is industrially viable.³ Despite these advantages, it is still suffering from poor chemical stability in an aqueous media, when its

electronic properties are needed. PSi is indeed prone to oxidation, which prevents to draw the quintessence from it. The oxidation of silicon (Si) is responsible for the formation of a thin silicon dioxide (SiO₂) layer at the surface of the sample, *i.e.* inside the pores. This mechanism appears spontaneously (native oxide) or under photo-thermal oxidative conditions,⁴ as it is often the case in plasmonics-based photocatalysis applications.⁵ Overall, this leads to the instability of the material (enhanced by its high surface-to-volume ratio) which results in a change in the optical properties,⁶ a reduction of the specific surface area⁷ and, obviously, in a modification of the electrical properties. These drawbacks have been frequently pointed out to explain what impedes the use of PSi for photoelectrodes design, while still acknowledging all its previously mentioned advantages. Several studies indeed showed that PSi is promising to perform water-splitting to produce hydrogen⁸ or artificial photosynthesis (AP)⁹ for the production of fuels, *i.e.* the conversion of CO₂ into added-value chemicals produced combining a catalysis reaction and sun energy.

The most conventional method to stabilize PSi is to oxidize it on purpose, by performing an annealing at high temperature (> 800°C) to purposely form stable Si-O bonds. ¹⁰ Here, the aim is to find alternative ultrathin materials to passivate PSi, as the presence of a stable SiO₂ layer leads to reduced performances of the photo-electrodes because it tends to convert the PSi skeleton to silicon oxide. Moreover, high-temperature annealing can lead to PSi damage due to the thermal stress.

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The data supporting this article have been included as part of the Electronic Supplementary Information available: (1) ALD window. (2) TEM images of TiO_2 films for samples from groups B and D. (3) Detailed high-resolution XPS spectrum of the Si 2s and 2p peaks. (4) Water contact angle measurements. (5) Complete FTIR spectra (400 to 4000 cm⁻¹). (6) Evolution of the absorption band at 620 nm of MB in aqueous solution. (7) Luminescence spectra. (8) Apparent rate constants for MB degradation. (9) ESI References. See DOI: 10.1039/x0xx00000x

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Consequently, when it is required to stabilize PSi without oxidizing it, thermal hydrosilylation has been often preferred. It allows the formation of Si-C bonds and can be performed using chemical treatments with 1-dodecene,¹¹ microwave-assisted hydrosilylation,¹² electrochemical grafting¹³ or thermal carbonization.¹⁴ These methods are the most common way to protect macroporous silicon from oxidation without drastically change its properties. It is therefore necessary to add functional materials if other properties are required. To do so, the recent trend is to use ALD or CVD of metal oxides to protect the porous media.¹⁵

To date, different kind of nanostructured silicon films have been passivated using ALD like nanoparticles-based ones¹⁶ or randomly etched n-doped films¹⁷ but present "thick" layers (>10 nm). Thus, advanced studies focusing into the stabilization of PSi layers by ultrathin pores coatings are still in infancy and mainly deal with specific applications.^{18, 19}

PSi oxidation mechanisms have been studied since its discovery. The three main techniques are infrared spectroscopy,^{20, 21} ellipsometric spectroscopy^{22, 23} and optical refractive index measurements.²⁴ The last two are generally preferred when the thickness of silicon dioxide grown at the surface of the substrate is monitored. It is still challenging to perform ellipsometry on macroporous silicon²⁵ and optical measurements do not allow knowing the kind of bonds present at the silicon surface. Consequently, this study favored the use of FTIR spectroscopy to monitor the Si-O-Si bonds at the surface of the coated and uncoated samples. Moreover, FTIR allows also detecting Si-H bonds, which are useful to know about the surface chemistry of the samples.

The oxidation mechanisms between planar and PSi are very similar. Due to its outstanding surface-to-volume ratios and high surface energies, macroporous silicon is much more prone to degradation associated with spontaneous oxidation than planar silicon.²⁶ Surface photo-oxidation causes various physicochemical changes in PSi films or planar silicon. These changes can be advantageous as it can lead to an increase in the emission quantum yield,²⁷ but they can be also disadvantageous because of the strong deterioration of long-range charge transport.²⁸

Consequently, despite recent advances in the field,²⁹⁻³¹ there is still a gap in the literature regarding the passivation of high specific surface materials by Atomic Layer Deposition (ALD) for applications in aqueous media. One of the reasons is that it is still challenging to coat porous materials conformally. A brilliant review paper from Rongé *et al.*,³² suggested that the undesired oxidation could be prevented by coating the pores with a thin passivating layer using ALD, and many recent studies confirmed this assumption.

If the coating material used to passivate silicon also has photocatalytic properties, the resulting photoelectrode could potentially perform carbon dioxide reduction reaction (CO_2RR) in water. This reaction, if properly controlled, allows producing renewable fuels. Its mastery is one of nowadays' main investigation field. Many catalysts have been studied to perform CO_2RR and other molecule splitting applications. However, some of them contain non-Earth abundant materials,

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like Ru, Pt, Ir³³⁻³⁵ or need expensive synthesis processine impeding market introduction of renewable gas compared to lower cost fossil-based fuels. A very common material that matches all the criteria for the development of PSi/ALD industrially compatible fabrication of PEC cells for solar fuel production is titanium dioxide (TiO₂). Here, TiO₂ is chosen because of i) its well-known thanks to its outstanding photocatalytic properties;³⁷ ii) the possibility to be deposited by ALD³⁸ in a highly conformal way; iii) the Earth-abundancy of titanium;³⁹ iv) its non-toxicity⁴⁰ and v) for its extremely high chemical stability. Additionally, TiO₂ is suitable for antireflection purposes⁴¹ and has been used previously in photovoltaic industry. ⁴²

For these reasons, it remains interesting to investigate the stabilizing capabilities of ALD TiO₂ films on PSi, in view of the design of future PEC cells. Previous achievements based on few nm-thick TiO₂,¹⁷ Al₂O₃,¹⁶ or 5 nm/5 nm Al₂O₃/TiO₂ ¹⁵ coatings showed that PSi stabilization is possible. In particular, it is worth investigating the stabilizing effect for very thin coatings, i.e. below 5 nm.

In this work, the stability of the coated PSi after exposure to aqueous medium at pH=7 is probed using Fourier Transform Infrared (FTIR) Spectroscopy and compared with bare PSi. The samples were directly exposed to sunlight, being placed by a window for 29 days (approx. 700 h). Moreover, the wetting properties of the coated samples show that a macro-PSi/TiO₂ composites are hydrophilic, which matches the requirements of photocatalysis cells, encouraging for the development of such devices. Here, we employed ALD based on emerging stop-flow strategy to allow successful ultrathin TiO₂ coating of PSi.

Additionally, an evaluation of the photocatalytic capabilities of ultrathin TiO_2 films was performed by monitoring the degradation of methylene blue (MB). It showed enhanced photocatalytic activities even for few angstrom-thick layers.

Previous works showed that ultrathin coating (typically below 2 nm) can protect porous materials against photocorrosion.⁴³ Ultrathin coating can also increase their chemical and temperature stability^{44, 45} and improve the biological response of the substrate.^{46, 47} On the other hand, other works showed that "thicker" (more than 20 nm) ALD layers also improve the photocurrent⁴⁸ and photocatalytic^{49, 50} response of different materials. In the latter case, however, the ALD coatings were performed on already partially photoactive materials. Here, we report a way to both stabilize and enhance the photocatalytic activity of n-type PSi films, thanks to subnanometric TiO₂ coatings.

Experimental

Porous silicon samples fabrication

Silicon wafers (0.49-0.505 Ω .cm resistivity, (100) orientation, double-side polished, boron-doped) were purchased from Siltronic (Germany). Aqueous hydrofluoric acid (HF) is 50 wt% concentrated.

The PSi samples were prepared by electrochemical etching of a double-sided polished heavily doped n-type silicon using a cell

purchased from AMMT Gmbh (Germany), which uses platinum electrodes, and a potentiostat as the current source, as previously described. The electrolyte used for the porosification is a 46:1 (v/v) deionized (DI) water and a HF solution. Cetyltrimethylammonium chloride (CTAC), а cationic surfactant, was used to obtain a better sample quality related to hydrogen releasing. Note that double-side polished wafers are not necessary to obtain the desired quality of PSi, but this choice ensures a sufficient level of reflection during the FTIR Spectroscopy measurements. To perform the etching, a constant voltage of 10 V was applied between two electrodes for 60 min, while placing the silicon sample between them. Lightening of the backside of the sample ensured the generation of photocarriers. Samples were then rinsed with DI water and dried under nitrogen flow or at ambient air. Afterwards, part of the samples were immediatelv characterized while others underwent ALD oxide coating.

Atomic Layer Deposition

ALD was performed with a BENEQ TFS 200 deposition tool. TiCl₄ (STREM Chemicals, Inc., U.S.A) and DI H₂O precursors (oxygen source) were fed into the reaction chamber from corresponding canisters at a temperature of 21 °C (cleanroom temperature). The samples were placed into the reactor, right after their etching. ALD processes were performed by using the prolonged exposure mode in a stop-flow reactor chamber. In this configuration, the chamber is isolated from the pump during precursor pulses, which allows precursors to penetrate deeply into the pores, ensuring a homogeneous coating throughout the whole depth of the porous matrix, which has a high aspect ratio. Each ALD full cycle is composed of a starting TiCl₄ halfcycle and a subsequent water precursor half-cycle. Each TiCl₄ half-cycle starts with the closing of the automatic pressure control (APC) valve followed by a pulse of precursor with a duration of 0.25 seconds for TiCl₄. After a 5 seconds delay to allow the precursor to react, the APC valve is fully opened for 10 seconds. This step is repeated twice before starting the next half-cycle to ensure the removal of both the unreacted precursor molecules and the reaction byproducts. Full cycles are repeated a given number of times depending on the growth rate and desired thickness. In our case, the full cycles were repeated 5, 21 or 210 times for samples groups B, C and D respectively, with a deposition temperature of 300°C. During the deposition, the gas pressure was kept lower than 5 mbar in the reaction chamber. A capillary tube fitted to the reactor was used to control the flow of precursors injected into the ALD chamber. The N_2 injection rate was 300 standard cubic centimetres per minute (sccm) into the precursor lines and 150 sccm into the outer reaction chamber.

Scanning electron microscopy

A JEOL JSM-7900F high-resolution field-emission scanning electron microscope (further noted as SEM) was used to observe and measure the thickness and pore diameter of the PSi layers.

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Contact angle measurement.

Contact angle measurements were performed with ARTISS GmBH DSA100 Drop Shape Analyzer using the sessile drop technique. For each sample, a 2 μ l of DI water droplet was placed onto the sample's surface with a syringe before taking a picture. Then, the DSA3 software analysed the image to extract the contact angles. Three water droplets were measured for each sample type (naturally oxidized flat silicon, PSi and TiO₂ coated PSi).

Fourier Transform Infrared Spectroscopy

The FTIR spectroscopy was performed under vacuum (<1 hPa) with a Vertex 70v spectrometer from Bruker Optics equipped with a glow bar radiation source and a DLaTGS MIR (4000 - 400 cm⁻¹) detector. Spectra were recorded in reflection mode with a resolution of 6 cm⁻¹ and 20 scans. The reference sample consisted of a flat silicon sample (not etched) of the same type of silicon as the one used for the fabrication of PSi. Native oxide was not removed prior to FTIR measurements. Note that the incident radiation crosses the film and is reflected by the polished backside of the sample, which means that the data correspond to a measurement of the radiation intensity that crossed the sample two times. The area of the Si-O-Si bands was estimated by numerical integration of the spectrum in the 1000 - 1200 cm⁻¹ region. No baseline was performed in the wavelength range of integration.

A first FTIR measurement was performed to define the t_0 of the experiment. For samples from group A it was performed right after the etching, while for groups B to D right after ALD. After the first measurement, samples were immersed into water and placed by a window, directly exposed to sunlight. At regular temporal intervals, samples were inspected using the following protocol: (i) N₂-flow drying for 30 s; (ii) hot plate drying at 50°C for 1 min to ensure moisture removal; (iii) FTIR spectroscopy measurements. The protocol was kept the same for all samples groups.

X-ray Photoelectron Spectroscopy

The surface chemical composition of the films was evaluated by X-ray photoelectron spectroscopy (XPS, Kratos Axis Supra) analysis. A monochromatic Al K α (1486.7 eV) X-ray source operated at 250 W was used. The binding energy scale was referenced to adventitious carbon (284.8 eV) and no charging neutralizer was used during the measurements.

Methylene blue degradation

The photocatalytic properties of the different structures were studied by following the degradation of an aqueous solution of methylene blue under light exposure. Samples from groups B to D were placed in a beaker containing 9 mL of a MB solution $(5.6 \times 10^{-3} \text{ mol/L})$ and were irradiated with a lamp (100 mW/cm²) for 110 min. The control solution did not contain any sample.

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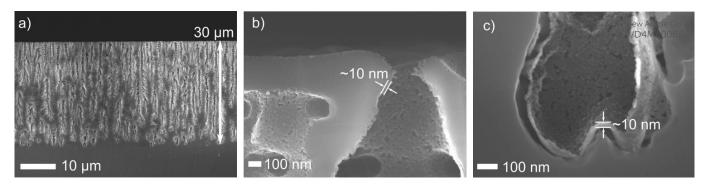


Fig. 1 SEM images of a group D sample showing the overall geometry of the macroporous silicon layer (a) and details of the TiO2 layer at the top (b) and the bottom of the pores (c).

The photocatalytic degradation was evaluated by monitoring the absorption of MB at 662 nm. The absorption spectra were acquired with a FLAME-S-XR1-ES UV-VIS spectrometer (200-1034 nm) connected to a computer equipped with OceanView software. Measurements were performed every 10 min placing the MB solution in a cuvette of 4.5 cm³. 3 samples of each group and 3 fresh control solutions were studied under the same conditions in order to compare the obtained results.

Results and discussion

Structural Characterization

Silicon was etched to obtain a 30 µm thick macroporous layer (see Fig. 1a). Macropores are preferred in order to ensure water penetration as the films are meant to operate in aqueous medium. The pores' morphology exhibited vertical macropores and thinner secondary pores (branches). Indeed, as the backside of the sample was lightened during the etching step, the photo-generated charge carriers migrate towards the backside side of the sample, leading to the formation of macroporous structures.⁵¹ The branches are typical for etching at low current densities and/or for high HF concentrations. Such structure ensures efficient gas evacuation during the etching step and such pore design is necessary for the photoelectrochemical cell operation.49

20 samples were prepared and separated in 4 groups (A, B, C and D) of 5 samples each. Samples from group A were kept "blank", whereas those from groups B, C and D were coated by ALD with 5, 21 and 210 cycles of TiO₂, respectively. The number of cycles was adjusted to obtain thicknesses of below 1 nm, approximately 1 and 10 nm, respectively. Deposition temperature was set to 300 °C, which usually leads to anatase structure, generally considered to be the most efficient photocatalytic structure of TiO₂.⁵⁰

Subsequent characterization of a group D sample by SEM proved that the TiO₂ film is conformal and the deposition successfully covered the bottom of the vertical pores, whilst penetrating also into the horizontally branched ones (Fig. 1b and 1c). The thickness of the film (approx. 10 nm) is homogeneous to the bottom of the pores.

Fig. 1c shows a partial delamination of the TiO_2 which we ascribe to the sample dicing process. However, TiO₂ is present down to the bottom of the pore. For the samples that underwent 5 and 21 ALD cycles, the given thicknesses (respectively less than 1 nm and ~1 nm) are an approximation from the data obtained by ellipsometry and transmission electron microscopy (TEM) on flat silicon substrates (see Fig. S2).

The survey spectra of the samples surface after ALD are presented in Fig. 2a. The O1s and Ti2p spectra of samples from groups B, C and D are presented in Fig. 2b, 2c and 2d, respectively. The Ti2p spectra are very similar for the three samples. The films exhibit a Ti2p_{3/2} peak at 458.2, 457.2 and 457 eV, and a Ti2p_{1/2} peak at 463.9, 462.9 and 462.8 eV. None of them shows asymmetries at their low energy side that could indicate the presence of Ti³⁺.

The position of the Ti2p photoelectron peaks and the spin-orbit splitting of the $2p_{1/2}$ - $2p_{3/2}$ doublet is about 5.7 in all the cases, which are both characteristic of TiO2.52 Furthermore, the spectrum of the group D sample exhibits a strong satellite at ~13.3 eV from the $2p_{3/2}$ peak, which is also a distinctive feature of TiO₂.⁵³ The low intensity of the Ti2p line for groups B and C samples prevents the observation of this peak in their corresponding spectra. On the contrary, the O1s line presents significant differences among the various samples. For 210 ALD cycles, the spectrum shows a peak at ~ 529.5 eV with a strong asymmetry at high binding energies.

The peak can be deconvoluted into three components at 531.2, 530.6 and 529.5 eV. The latest is the most significant and is ascribed to oxygen bound to tetravalent Ti ions, whereas the other two indicate the presence of Ti-OH⁵⁴ and Si-O⁵⁵ bonds at the surface of the films. For groups C and B samples, however, the peak is located at ~ 530.4 eV and ~ 531 eV, respectively, and the shoulder appears at the lower energies side, since in this case the main contribution comes from the Ti-OH bonds and not from the Ti-O ones. This is explained because of the low thickness of the TiO₂ film for these two samples (\sim 1 nm and <1 nm), which reduces the weight in the XPS spectra of the Ti-O bonds coming from TiO₂ while increasing the influence of other species that are present at the surface. In a similar fashion, the low thickness of the coatings explains the appearance of the Sirelated lines in the photoelectron spectra of these two samples that, however, are hardly visible for 210 ALD cycles (Fig. S3).

This is expectable because, in this case, the thickness is at the limit of the typical values for the information depth of XPS technique (~10 nm) and so the signal comes mainly from the TiO_2 layer, whilst for the other two the signal contains as well information from the PSi substrate. The presence of Si-O bonds in the spectra of the three samples indicates the formation of This article is licensed under a Creative Commons Attribution-NonCommercial 3.0 Unported Licence

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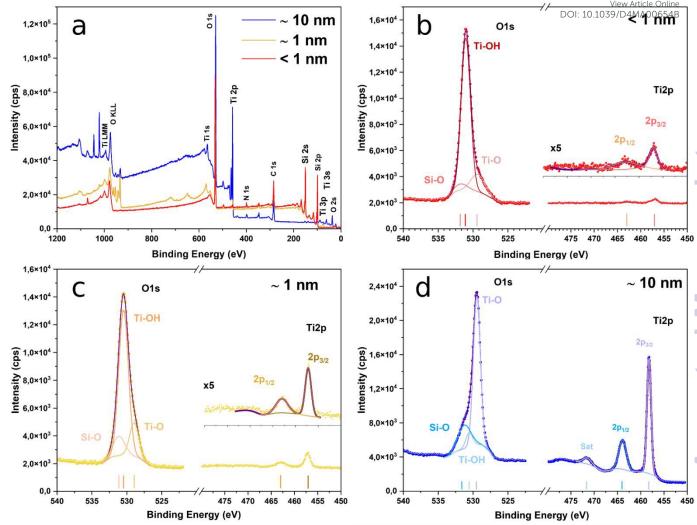


Fig. 2 Survey XPS spectra of the various studied samples (a) and detailed high resolution XPS spectra of the O1s and the Ti2p peaks for the various PSi layers coated with sub-1nm (b); about 1 nm (c); and about 10 nm (d) ALD TiO₂ layers. In (b), (c) and (d), solid dots correspond to the experimental data, whereas the solid purple line corresponds to the fit.

native SiO₂ at the surface of the PSi substrate prior to TiO_2 covering. Its presence is inherent to the process as the oxide appears during the few minutes between the PSi etching and the beginning of the ALD step. However, we can see that the native oxide does not seem to affect the protective role of TiO_2 (see following sections).

ALD deposition of TiO₂ on SiO₂ by successive pulses of TiCl₄ and H₂O occurs through a complicated chain of reactions happening on the surface,⁵⁶ and which evolves as the number of cycles increases. Gu and Tripp shown that during the first cycle, TiCl₄ vapour reacts with 100 % of the isolated SiOH (silanol) groups present at the surface of silica leading to a combination of Ti-O, Si-O-Ti and Si-O-Ti-Cl species. The addition of water vapor in the second cycle leads to the cleavage of some of the freshly formed Si-O-Ti bonds, resulting in the regeneration of silanol groups available to react with TiCl₄. However, as the number of ALD cycles increases and the TiO₂ structure propagates, the number of Si-O-Ti bonds cleaved by the water vapour decreases. After some few cycles, the reacting surface corresponds only to titania (the SiO₂ layer is fully covered) and the TiCl₄ adsorption occurs via direct reaction with TiO₂ and with polymerization

with the adsorbed water layer. We can then consider that, at this stage, all the Si-O-Si bonds are saturated, i.e., not available for further reactions. As a result, the growth of new SiO₂ layers is inhibited, leading to a fully stabilized surface even though the deposition occurs in presence of H_2O .

Protective Role of TiO₂ Films against Oxidation Process in Water.

Wetting properties first studied for flat silicon, bare PSi and TiO_2 -coated PSi (~10nm, 210 cycles) by water contact angle measurements. Fig. S4 presents the obtained results. The porosification of these samples or the ALD coating of the porous structure showed relatively small effects on the wetting properties, with all contact angles in the range 20°- 45°. This wide range is most likely due to the morphological inhomogeneity at its surface. It is probably not related to possible contamination by adsorption of hydrocarbons because the samples were only exposed to deionised water during the experiments. We can conclude that the TiO_2 coating has no influence on the water penetration and ALD coating, the

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substrates remained hydrophilic, which make them suitable for applications in aqueous media.

It is to be noted that ALD of metal oxides is known to passivate surfaces like flat silicon. The passivation matchar are associated and a solution of the silicon of the solution of the silicon of the solution of the soluti

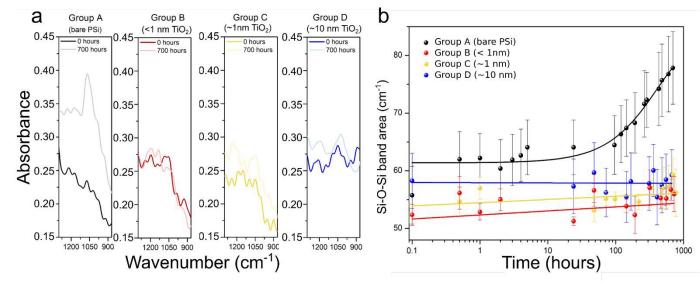


Fig. 3 Detail of the Si-O-Si band of the FTIR spectra recorded for oxidation times of 0 and 700 hours (a) and evolution of the Si-O-Si band area as a function of the oxidation time (b). Lines in b are only a guide to the eye. Experiments were conducted in water.

This allowed to assess the impact of the TiO_2 films on the oxidation process in water by submerging the samples into water and measuring their FTIR spectra along the process, monitoring the evolution of the Si-O band (1000–1200 cm⁻¹) over 700 hours (*i.e.* 29 days). A representative example of the spectra recorded prior to exposure to oxidation conditions, and after the 700 hours of water immersion is presented in Fig. 3a. The full FTIR spectra are available in Fig. S5. For the uncoated samples (group A) there is a remarkable increase of the Si-O-Si band when exposing samples to oxidative conditions, and this is true even for only 30 minutes of water immersion. Opposite, the FTIR spectra of samples coated with TiO₂ thin films do not show significant differences, regardless of the duration of the water exposure.

The Si-O-Si band area as a function of the oxidation time is shown in Fig. 3b. Each value in the graph represents the mean of the calculated values of the band area for the 5 samples composing each set of samples. For group A samples the Si-O band increases significantly right after exposure to the oxidation conditions.

After that, an induction time in which the area increases only slightly is observed, followed by an exponential grow after \approx 96 hours of immersion into water. For samples from groups B, C and D, this first oxidation upon immersion was not noticed. The signal of the Si-O-Si band was increasing only slightly over the time. Although we cannot conclude on what would happen after the 29 days of water exposure measurement, it is likely that TiO₂ chemical stability ensures a longer-term passivation of porous silicon within aqueous media. Indeed, the kinetics of Si-O-Si bonds formation is not even measurable. These observations confirm that the PSi layer was protected from oxidation thanks to the TiO₂ layer even for only 5 ALD cycles (*i.e.* less than 1 nm-thick layer).

wide band gap semiconductors (e.g. ZrO_2 , Ta_2O_3 , HfO_2) or insulators (e.g. Al_2O_3) and can be used as dielectrics in microelectronic devices.⁵⁷ However, to our knowledge they do not show photocatalytic activity. Ultrathin TiO₂ was chosen in this work for its known photocatalytic effects and its interesting optical properties, ^{58, 59} also used for solar cells fabrication.

Influence of the Coating on Methylene Blue Degradation.

The influence of the number of TiO_2 ALD cycles on the photocatalytic activity of n-type PSi/TiO_2 was explored. The degradation of MB was studied by monitoring the evolution of its absorption peak at 662 nm (see Fig. S6) on groups B, C and D samples and on a control solution. Group A samples (uncoated) were not tested because PSi is known to have, if not protected, no photocatalytic activity due to corrosion.⁶⁰ Since the catalytic activity depends on the contact area with the reactants, we do not consider here a comparison with flat silicon samples.

It must be considered that the lamp used for the experiment emits both UV and visible light (see Fig. S6). This results in the heating of the solutions (in our case from 20°C to 43°C for our 2 hours measurements) and hence, potentially to selfdecomposition of MB. Moreover, MB molecules can absorb light in the region of 500–700 nm leading to the formation of singlet and triplet species by electronic transition and intersystem crossing,⁶¹ causing luminescence quenching. In addition, MB can also undergo light-driven self-decomposition to a certain extent.⁶² The combination of these phenomena can explain why degradation appears also on the control solution that contains only MB.

Fig. 4a shows the percentage of decomposition of MB as a function of time whereas Fig. 4b presents the plot of $\ln(\frac{C_0}{C_t})$ as a function of time. The percentage of decomposition was

structural and electrical properties that can be used for development of electrical/optical device?^{OI: 10.1039/D4MA00654B}

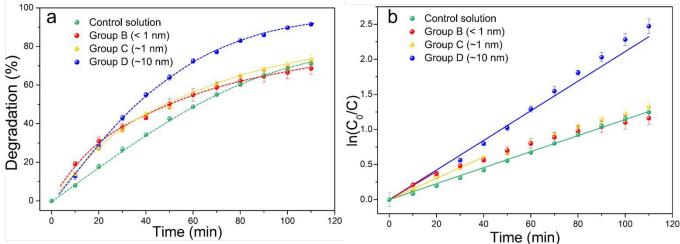


Fig. 4 Degradation rates of group B, C and D samples and control solution containing only MB (a). Plot of the MB decomposition in logarithmic scale as a function of time (b).

times t = t and t = 0, respectively. In correlation with the Beer-Lambert law, the A_t/A_0 ratio is equivalent to the C_t/C_0 ratio, where C_t is the concentration of the MB solution at time t and C_0 the initial concentration. The decomposition of MB in aqueous solution can be described using the pseudo-first order Langmuir-Hinshelwood kinetic model in accord to $\ln(\frac{C_0}{C_t}) = kt$

(2), where k is the apparent (pseudo-first) rate constant.

Groups B and C samples follow very similar degradation kinetics whilst the fastest degradation corresponds to the 10 nm-thick coating layers (group D), with an apparent rate constant that is a 46% higher than for the photofading process, (see Table S1 for the values of the resulting apparent rate constants). Interestingly, all samples exhibit a faster degradation than the control solution, with very similar degradation kinetics that follow a linear behaviour, which means that TiO₂ films as thin as some angstroms still produce short-term photocatalytic effects. However, the trend for groups B and C samples clearly deviates from the pseudo-first kinetics after 20 and 40 min from the beginning of the light exposition, respectively. For both groups, at long times (t>80 min) the degradation kinetics becomes comparable to that of the control solution. The deviation from linearity is particularly high for group B samples, reaching up to 88% at the end of the experiment. This can be explained because of the very low thickness of the TiO₂ films: at short times, there are plenty of sites available at the surface for adsorption of MB molecules and, as the dye is decomposed, new free ones rapidly replace them. This process, however, alters the TiO₂ and since the films are thinner than 1 nm, after a certain time no more catalyst is left and the only mechanism of degradation of MB is photofading, leading to a much slower decomposition rates.

Note that the electrical properties are not investigated here are as they were previously studied in depth on planar silicon.⁶³ However, performing this study on coated PSi would constitute an original work. Nevertheless, it is expected that TiO₂ coatings of PSi will form nanostructures possessing unique optical,

Conclusions

In this work, we used Atomic Layer Deposition of TiO_2 to chemically stabilize and protect PSi, which is otherwise prone to photo-oxidation. We demonstrated that sub-nanometric ALD coatings are able to fully – and conformally– coat the pores and, thanks to FTIR spectroscopy, we demonstrated that they can prevent oxidation even in aqueous media. Moreover, our experiments point out that this passivation function takes place in spite of the presence of a thin layer of native SiO₂ between the surface of PSi and the TiO₂. In addition, by monitoring the degradation of methylene blue in the presence of functionalized samples, we proved that these ultrathin TiO₂ layers on macroporous Si show photocatalytic activity. Again, the native oxide layer occurring prior to ALD coating does not prevent the interaction between TiO₂ and PSi.

Our study provides a contribution towards the production of stable photoactive electrodes based on porous films using a very small amount of catalysts. The stability of PSi should not be any longer considered as a serious bottleneck for water-splitting of CO_2 reduction applications.

Author contributions

Bachar Al Chimali: ALD, FTIR and MB degradation investigation, formal analysis, writing-original draft. Irene Carrasco: FTIR investigation, FTIR validation, FTIR and XPS formal analysis, writingoriginal draft, review and editing. Thomas Defforge: PSi etching methodology and validation. Romain Dailleau: ALD methodology and validation. Lisa Monnier: contact angle investigation and formal analysis. Kaushik Baishya: XPS investigation. Jan M. Macak: conceptualization, resources, supervision, writing-review and editing. Gaël Gautier: conceptualization, resources, supervision, writing-review and editing. Brice Le Borgne: conceptualization, supervision, formal analysis, writing-original draft, review and editing.

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Conflicts of interest

There are no conflicts to declare.

Data availability

All data are available in agreement with the data availability statement (DAS).

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